# TEST REPORT PV Module Safety Qualification

## IS/IEC 61730-1:2016 Part 1: Requirements for construction IS/IEC 61730-2:2016 Part 2: Requirements for testing

Report Number:	
Date of issue:	
Total number of pages:	
Name of Testing Laboratory	
preparing the Report:	
Applicant's name:	
Address:	
Test specification:	
Standards:	IS/IEC 61730-2:2016 in conjunction with IS/IEC 61730-1:2016
Test procedure:	IS/IEC 61730-2:2016 in conjunction with IS/IEC 61730-1:2016
Non-standard test method::	N/A
Test Report Form No:	IS/IEC 61730-1:2016 & IS/IEC 61730-2: 2016
Test Report Form(s) Originator :	BIS
Master TRF:	Dated XXXX-XX-XX
General disclaimer:	
The test results presented in this report	relate only to the object tested.

Test item description:	
Trade Mark:	
Manufacturer:	
Address:	
Model/Type reference:	
Ratings:	
Deenensible Testing Laboratory (as appli	
Responsible Testing Laboratory (as appli	cable), testing procedure and testing location(s):
Testing Laboratory (as appli     Testing Laboratory:	cable), testing procedure and testing location(s):
· · · · · ·	
Testing Laboratory:	
Testing Laboratory: Testing location/address	
Testing Laboratory:       Testing location/address       Tested by (name + signature):	

List of attachments (including a total number of pages in each attachment):						
	attachment number / number of pages					
Installation manual:						
Drawings mechanical:						
Circuit diagram:						
Photographs:						
Component datasheets / certificates						
Others:						
Summary of testing:						
Tests performed (name of te	est and test clause):	Test location:				
The product fulfile the requi	$\Box$ The product fulfils the requirements of :					
		ext in parenthesis, leave it blank or delete the whole				
sentence, if not applicable)		At in parentilesis, leave it blank of delete the WHOLE				

Copy of marking plate:

Test item particulars:	
Accessories and detachable parts included in the evaluation:	
Mounting system used	
Other options included	
Possible test case verdicts:	
- test case does not apply to the test object	N/A
- test object does meet the requirement	P (Pass)
- test object does not meet the requirement	F (Fail)
Abbreviations used in the report:	
Pmax – Maximum power	HF – Humidity Freeze
Vmp – Maximum power voltage	DH – Damp Heat
Imp – Maximum power current	TC – Thermal Cycling
Isc – Short circuit current	α – Current temperature coefficient
Voc – Open circuit voltage	$\beta$ – Voltage temperature coefficient
FF – Fill factor	$\delta$ – power temperature coefficient
STC – Standard Test Conditions (25°C, 1 000 W/m²)	NMOT – Nominal Module Operating Temperature (20°C, 800 W/m <sup>2</sup> )
MQT – Module Quality Tests	VFMrated – Rated diode(s) forward voltage
VFM – Measured diode(s) forward voltage	NP – Nameplate
$m_1$ – the measurement uncertainty in % of laboratory for Pmax	$m_2$ – the measurement uncertainty in % of laboratory for Voc
$m_3$ – the measurement uncertainty in % of laboratory for lsc	$t_1$ – the manufacturer's rated lower production tolerance in % for Pmax
$t_2$ – the manufacturer's rated upper production tolerance in % for Voc	<i>t</i> ₃– the manufacturer's rated upper production tolerance in % for lsc
r – Pmax measurement reproducibility	
Testing Dates (YYYY-MM-DD)	
Date of first test item received	
Dates of tests (beginning/end)	

General remarks:		
Decision Rule:		
"(See Enclosure #)" refers to additional information appended to the report. "(See appended table)" refers to a table appended to the report.		
Throughout this report a $\square$ comma / $\square$ point is used as the decimal separator.		
This Test Report Form is intended for the investigation of PV modules in accordance with IS/IEC 61730-2:2016 in conjunction with IS/IEC 61730-1:2016		
Name and address of factory (factories)		

Product Electrical Ratings:	
Monofacial Module:	
Module type	
Voc [V] /Tolerance	
Vmp [V]	
Imp [Adc]	
Isc [Adc] /Tolerance	
Pmp [W] /Tolerance	
Maximum system voltage [V]	
Maximum Over-Current Protection Rating [A]	
Remarks:	

### **Bifacial Module:**

	Module type		
	P <sub>max</sub> [W] /Tolerance		
	V <sub>oc</sub> [V] /Tolerance		
STC condition	Isc [Adc] /Tolerance		
	V <sub>mp</sub> [V]		
	Imp [Adc]		
	P <sub>max</sub> [W] /Tolerance		
BNPI condition	Voc [V] /Tolerance		
	Isc [Adc] /Tolerance		
	φP <sub>max</sub>		
Bifaciality coefficient	φV <sub>oc</sub>		
	φl <sub>sc</sub>		
	Maximum system voltage [V]		
	Maximum Over-Current Protection Rating [A]		

Product Safety Ratings		
Maximum systems voltage (Vsys):		V
Maximum over-current protection rating:		A
Class in accordance with IEC 61140:	See clause 4.1	
Intended use (list details):	See clause 4.5	
The modules are intended for a maximum operating altitude [meters above sea level] of:		m
Recommended maximum series/parallel module configurations:		

## General product information:

General product information.	
Modifications:	
$\Box$ Initial module design qualification	
□ Extension of module design qualification	
□ Original test report ref. no:	
Model differences and modification:	
$\Box$ Test programs for crystalline silicon PV modules	Test programs for thin-film PV modules
<ul> <li>4.2.1 Modification to frontsheet</li> <li>4.2.2 Modification to encapsulation system</li> <li>4.2.3 Modification to cell technology</li> <li>4.2.4 Modification to cell and string interconnect material or technique</li> </ul>	<ul> <li>4.3.1 Modification to frontsheet</li> <li>4.3.2 Modification to encapsulation system</li> <li>4.3.3 Modification to front contact (e. g. TCO)</li> <li>4.3.4 Modification to cell technology</li> </ul>
<ul> <li>4.2.5 Modification to backsheet</li> <li>4.2.6 Modification to electrical termination</li> <li>4.2.7 Modification to bypass diode</li> <li>4.2.8 Modification to electrical circuitry</li> </ul>	<ul> <li>4.3.5 Modification to cell layout</li> <li>4.3.6 Modification to back contact</li> <li>4.3.7 Modification to edge deletion</li> <li>4.3.8 Modification to interconnect material or</li> </ul>
<ul> <li>4.2.9 Modification to edge sealing</li> <li>4.2.10 Modification to frame and/or mounting structure</li> </ul>	technique 4.3.9 Modification to backsheet 4.3.10 Modification to electrical termination
<ul> <li>4.2.11 Change in PV module size</li> <li>4.2.12 Higher or lower output power (by 10 % or more) with the identical design and size and using the identical cell process</li> </ul>	<ul> <li>4.3.11 Modification to bypass diode</li> <li>4.3.12 Modification to edge sealing</li> </ul>
<ul> <li>4.2.13 Increase of over-current protection rating</li> <li>4.2.14 Increase of system voltage</li> <li>4.2.15 Change in cell fixing tape</li> </ul>	<ul> <li>4.3.13 Modification to frame and/or mounting structure</li> <li>4.3.14 Change in PV module size</li> <li>4.3.15 Higher or lower output power (by 10 % or more) with the identical design and size</li> <li>4.3.16 Increase of over-current protection rating</li> <li>4.3.17 Increase of system voltage</li> </ul>

6 SAMPLI	NG				
	☐ The modules tested were taken at random fr subjected to manufactur and inspection for safet	om a production batc rer's normal quality co	h and		
	□ The modules tested were prototypes of a ne from a production batch				
		Preconditioning of test samples were performed within IS 14286 performance testing			
	Preconditioning of te separately from IS 1428	est samples were per 6 performance testing			
Supplemer	ntary information:				·
Module gr	oup assignment:				
Sample #	Sample Group ID	Type/model		Sample S/N	Remark
1	Control				
4	F				
5	С				
7	D				
9	E				
13	А				
14	В				
15	B1				
16	G				
17	Ignitability				
18	Module-Break				
19	Peel-Reference				
	Lap shear				
	Fire test				
Remarks:					·

Remarks:

Use the "General product information" field to give any information on model differences within a Note (1) product type family covered by the test report and describe the range of electrical and safety ratings, if the TRF covers a type family of modules.

Note (2) Use Annex 2 to list the used materials and components of the module (manufacturer/supplier and type reference)

The module numbers/identifiers are set in accordance to IEC 62915 Photovoltaic (PV) modules -Note (3) Retesting for type approval, design and safety qualification, Annex A3 of IEC 62915

## Page 10 of 84

4 Classification, applications and intended use		
4.1 General		
The module has been evaluated for the following Class (IEC 61140)	<ul><li>□ Class 0</li><li>□ Class II</li><li>□ Class III</li></ul>	
4.5 Intended use		
PV modules are installed in the following special app	lications:	—
Building attached PV (BAPV)	□ yes □ no	
Building integrated PV (BIPV)	□ yes □ no	—
Applications in areas where snow and / or wind load exceeding loads as tested in IS/IEC 61730-2: 2016 are expected	□ yes □ no	
Applications at environmental temperature exceeding the limits indicated in of IS/IEC 61730- 1:2016	□ yes □ no	
other (please specify)	$\Box$ yes, as follows:	
	🗆 no	
5 Requirements for design and construction		
5.1 General		
PV module suitable for operation in outdoor non- weather protected locations, exposed to direct and indirect (albedo) solar radiation, in an environmental temperature range of at least –40°C to +40°C and up to 100 % relative humidity as well as rain.		
Product shipped from the factory as	<ul> <li>completely assembled</li> <li>subassemblies</li> </ul>	—
The provided assemblies of the product do not involve any action that is likely to affect compliance with the requirements of the IS/IEC 61730 series.		
Incorporation of a PV module into the final assembly does not require any alteration of the PV module from its originally evaluated form.		
Equipotential bonding continuity is not interrupted by installation		
Any adjustable or movable structural part are provided with a locking device		
PV modules have no accessible burrs, sharp edges or sharp points	See Table 45	
Parts are prevented from loosening or turning	See Table 47 and 48	

5.2 Mark	ing and doo	cumentation	
5.2.1		ions related to safety are in an official ge of the country where the equipment is to alled.	
5.2.2 Mai			
5.2.2.1 G			
		V module includes the following clear and inc	-
		Name, registered trade name, or registered trade mark of manufacturer	
	b)	Type or model number designation	
	c)	Serial number	
		Date and place of manufacture; alternatively serial number assuring traceability of date and place of manufacture	
	e)	Polarity of terminals or leads	
	f)	"Maximum system voltage" or "Vsys"	
	g)	Class of protection against electrical shock, in accordance with Clause 4 of IS/IEC 61730-1:2016	
		"Voltage at open-circuit" or "Voc" including manufacturing tolerances	
	i)	"Current at short-circuit" or "Isc" including manufacturing tolerances	
	j)	"PV module maximum power" or "Pmax" including manufacturing tolerances	
	k)	"Maximum overcurrent protection rating"	See Table 34
	test con	trical data are shown as relative to standard ditions (STC) (1 000 W/m <sup>2</sup> , (25 $\pm$ 2) °C, according to IEC 60904-3).	
	Internat	ional symbols are used where applicable.	
		nectors or wiring are marked in accordance 52852 with a symbol "Do not disconnect bad".	
		or warning notice are imprinted or labelled ocnnector	
		nectors are clearly marked indicating the I polarity.	
	(IEC 60 symbol	ss II and Class 0 PV modules, the 417-6042: Caution, risk of electric shock) is applied near the PV module electrical tion means.	

	Page 12 of 84	Report No.
P١	V modules are marked to indicate the class	□ class II: □
		□ class III: (III)
		🗆 class 0: no symbol
	V modules provided with a functional earth onnection (see section 5.2.2.2.2)	
or	V modules with terminals for field wiring rated hly for use with copper wire are marked, at or djacent to the terminals, with the statement "Use opper wire only", "Cu only", or the equivalent.	
or ar	V modules with terminals for field wiring rated only for use with a different specific wiring material re marked with a similar statement referring to the ated material.	
5.2.2.2 Symbo	bls	
5.2.2.2.1 Equip	potential bonding	
	onding conductor for equipotential bonding is entified with:	
	o other terminal or location is identified in this anner	
5.2.2.2.2 Func	tional earthing	
	eld installed functional earthing conductor is entified with the symbol:	
5.2.3 Documer	ntation	
	ocumentation concerning electrical and echanical installation provided.	
	lass (see 5.2.2.1) is stated, including specific nitations required for that Class.	
Er	nvironmental conditions to which the module has b	een qualified are stated.
	oncerning temperature range, typically -40 °C to 40 °C	
СС	oncerning wind/snow load including safety factor	
m	ocumentation for safe installation, use, and a nation and the same and a second s	
Tł	he documentation contains the following informatio	n: —
	<ul> <li>Name, registered trade name, or registered trade mark of manufacturer</li> </ul>	
	<ul> <li>Type or model number designation</li> </ul>	
	<ul> <li>"Maximum system voltage" or "Vsys"</li> </ul>	
	<ul> <li>Class of protection against electrical shock</li> </ul>	
	<ul> <li>"Voltage at open-circuit" or "Voc" including manufacturing tolerances at STC</li> </ul>	

	Page 13 of 84	Report No.	
_	"Current at short-circuit" or "Isc" including manufacturing tolerances at STC		
-	"PV module maximum power" or "Pmax" including manufacturing tolerances at STC		
-	"Maximum overcurrent protection rating"	See Table 34	
_	Recommended maximum series / parallel PV module configurations		
_	Temperature coefficient for voltage at open-circuit		
_	Temperature coefficient for maximum power		
_	Temperature coefficient for short-circuit current		
standa	strical data shall be shown as relative to rd test conditions (1 000 W/m <sup>2</sup> , (25 $\pm$ 2) °C, according to IEC 60904-3).		
Interna	tional symbols are used		
	ectrical documentation includes a detailed des tion wiring, including:	scription of the electrical	
_	Minimum cable diameters for PV modules intended for field wiring		
-	Limitations on wiring methods and wire management that apply to the junction box for the PV module		
-	Size, type, material, and temperature rating of the conductors		
-	Type of terminals for field wiring		
-	Specific PV connector model / types and manufacturer to which the PV module connectors can be mated		
-	The bonding method(s), if applicable, is specified including all provided or specified hardware		
-	The type and ratings of bypass diode to be used (if applicable)		
-	Limitations to the mounting situation (e.g. slope, mounting means, cooling)		
_	A statement indicating	<ul> <li>fire rating(s) and applied standards</li> <li>statement regarding resistance to external fire sources not evaluated</li> </ul>	
-	Limitations regarding fire ratings (e.g. installation slope, sub structure or other applicable installation information)		

Page	14	of	84
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<ul> <li>A statement indicating the minimum mechanical means for securing the PV module</li> </ul>	See Table 14
<ul> <li>A statement indicating the maximum altitude</li> </ul>	
The documentation for roof mounting includes:	_
<ul> <li>A statement indicating the minimum mechanical means for securing the PV module to the roof</li> </ul>	See Table 14
<ul> <li>Specific parameter(s) when the fire rating is dependent on a specific mounting structure are provided e.g. specific spacing, or specific means of attachment to the roof or structure.</li> </ul>	
A statement concerning artificially concentrated sunlight	
Assembly instructions are provided with a product shipped in subassemblies, and are detailed and adequate to the degree required to facilitate complete and safe assembly of the product	
The installation instructions include relevant parameters specified by manufacturer or the following statement or the equivalent: "Under normal conditions, a photovoltaic module is likely to experience conditions that produce more current and/or voltage than reported at standard test conditions. Accordingly, the values of ISC and VOC marked on this module should be multiplied by a factor of 1,25 when determining component voltage ratings, conductor current ratings, and size of controls connected to the PV output."	

5.3 Electrical components and insulation			
5.3.2 Internal wiring			
Internal wiring has sufficient current carrying capacity for the relevant application.	See Table 34		
5.3.3 External wiring and cables			
External wires and cables fulfil the requirements of	□ EN 50618 □ IEC 62930.		
5.3.4 Connectors			
External DC connectors fulfil the requirements of IEC 62852.			
5.3.5 Junction boxes for PV modules			
Junction boxes for PV modules fulfil the requirements of IEC 62790.			
5.3.6 Frontsheets and backsheets			
Frontsheet:		_	

Page	15	of	84
Page	15	OI	04

Material Frontsheet:		<ul> <li>Glass</li> <li>Polymeric material</li> <li>Others.</li> </ul>	
Polymeric frontsheets meet relev of section 5.5.2	ant requirements	See 5.5.2	
Polymeric frontsheets used as re	lied upon insulation	fulfil requirements of	—
- 5.6.4.3 for insulation in the	nin layers	See 5.6.4.3	
- 5.5.2.3 for electrical insu	lation	See 5.5.2.3	
Thermal index frontsheet (see al	,	□ TI : □ RTE : □ RTI :	_
Adhesion to encapsulant or glass		Compliance is checked by test sequences of IS/IEC 61730-2: 2016 listed in this report.	
Backsheet:			
Material Backsheet:		<ul> <li>Glass</li> <li>Polymeric material</li> <li>Others.</li> </ul>	
Polymeric backsheets meet releved of section 5.5.2	ant requirements	See 5.5.2	
Polymeric backsheets used as re	elied upon insulation	n fulfil requirements of	
- 5.6.4.3 for insulation in the	nin layers	See 5.6.4.3	
- 5.5.2.3 for electrical insu	lation	See 5.5.2.3	
Thermal index backsheet (see al	so 5.5.2.3.3):	□ TI : □ RTE : □ RTI :	
Adhesion to encapsulant or glass		Compliance is checked by test sequences of IS/IEC 61730-2: 2016 listed in this report.	
5.3.7 Insulation barriers			
Polymeric insulation barrier meet requirements of 5.5.2	s the relevant	See 5.5.2	
Barrier held in place while keepir electrical and mechanical proper			
Removal of barrier only possible	by using a tool		
5.3.8 Electrical connections			
5.3.8.1 General			
Terminations are so designed, th pressure is not transmitted throu material except ceramic, mica or material. Compliance checked by	gh insulating other adequate		
Measures are taken to prevent c becoming loose, e.g. by using a		See Table 11 and Table 48	
End of a stranded conductor is n soft soldering.	ot consolidated by		

Page 16 of 84	Report No.
Measures are taken to prevent contact stress impairing electrical conductivity.	
5.3.8.2 Terminals for external cables and PV connector ribbo	ons
Terminals for electrical connections are suitable for the type and range of conductor cross- sectional areas and meet the relevant requirements of IEC 62790.	
Insulated terminals are designed such that a reduction of clearances and creepage distances by displacement is prevented.	

5.3.8.3 Splices and connections inside a PV module			
	Splices and connections are mechanically secured and provide electrical continuity.		
	Electrical connections are soldered, welded, conductively adhered, crimped, or otherwise securely connected.		
	A soldered or conductively adhered joint is additionally mechanically secured.		
5.3.9 Encap	sulants		
	Thermal properties are sufficient for intended application.		
	The insulation properties according to 5.5.2.3 are met, if applicable.	See 5.5.2.3.2	
5.3.10 Bypa			
	Bypass diodes are rated to withstand the current and voltage for their intended use.	See Table 31 and Table 46	
5.4 Mechan	ical and electromechanical connections		
5.4.1 Gener	al		
	Type of connection:	<ul> <li>Connection within frame</li> <li>Mounting interfaces via adhesive</li> <li>frame to clamp a mounting system</li> <li>Equipotential bonding</li> <li>Attachment of junction box</li> <li>mechanical connections within the laminate:</li> </ul>	
	Mechanical connections are durable to withstand the thermal, mechanical, and environmental stresses occurring in the application.	See Table 38, Table 13 and Table 11	
	Removable parts are only detachable with the aid of tools.		
	Lids attached without screws have one or several detectable facilities for enabling tools.		
	No contact of tools with the live parts when the lid is removed.		
	No friction between surfaces as the sole means to inhibit the turning or loosening of a part, unless provisions to prevent unintended movement or rotation of the component is given.		
5.4.2 Screw	connections		
	Screws and mechanical connections withstand the mechanical stresses occurring in normal use.		
	Screws are not made of a material which is soft or liable to creep.		
	Screws used to provide mechanical stability and continuity for equipotential bonding withstand the mechanical stresses occurring in normal use.		

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	At least one screw per electrical- mechanical connection ensures the electrical connection between the metallic components	
	Screws used for mechanical and electrical connections with a nominal diameter of less than 3 mm are screwed into metal.	
	For screws used for mechanical and electrical connections two full threads are engaged into the metal.	
	Screwed and other fixed connections are in such a way that they do not come loose through torsion, bending stresses, vibration, etc.	
5.4.3 Rivets	; ;	
	Rivets which serve as electrical as well as mechanical connections are locked against loosening.	
5.4.4 Threa	d-cutting screws	
	Thread-cutting and self-tapping screws are not used for interconnection of current-carrying parts made of a material which is soft or liable to creep.	
	No thread-forming or thread-cutting (self-tapping) screws (sheet metal screws) are used for the connection of current-carrying parts.	
	Thread-cutting (self-tapping) screws not be used if they are likely to be operated by the user or installer.	
	Thread-cutting and thread-forming screws, used to provide continuity for equipotential bonding, are such that it is not necessary to disturb the connection in normal use.	
	For equipotential bonding one screw is permitted if two full threads engage the metal	
5.4.5 Form/	press / tight fit	
	Form/press/tight fits of metallic components which are not separately equipotentially bonded are electrically connected.	
	Requirements of MST 32 and MST 34 are met, continuity of equipotential bonding (MST 13) is provided before and after the MST 32 and MST 34 tests	See Table 38, Table 39 and Table 11
5.4.6 Conne	ections by adhesives	
	Connections by adhesive for mounting means are sufficient.	See Table 38, Table 39 and Table 11
	Fixing of junction box by adhesive is sufficient.	See Table 27, and Table 10
	Adhesion of a polymer relied upon for insulation to another insulating layer is appropriate for the application.	
	Requirements for adhesive materials are met	See 5.5.4
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Page 19 of 84	Report No.
Connection by adhesive which is considered as	See 5.6.4.2
cemented joint fulfils the requirements of 5.6.4.2.	
5.4.7 Other connections	
Other connections such as, welded or soldered, as well as Materials and processes for creating the connections are appropriate for the application and for the intended use.	See Table 6 and Table 43
Other connections which are relied upon for equipotential bonding fulfil the requirements of (MST 13).	See Table 11
5.5 Materials	
5.5.2 Polymeric materials	
5.5.2.1 General	
Polymeric materials are able to durably and safely withstand the electrical, mechanical, thermal, environmental, and corrosive stresses occurring in the application.	Assessed polymeric parts see Annex 2 (BOM). Test results see subsequent sections
Polymeric materials are resistant to electrical and mechanical property degradation.	Test results see subsequent sections
Polymeric parts which ensure either the electrical or mechanical safety of the PV module, or both, are resistant to electrical and mechanical property degradation.	Test results see subsequent sections
They comply with the requirements of the materials creep test (MST 37) depending on their constructive function in the PV module.	See Table 13
Polymeric material used as a part of a cemented joint fulfils additionally the requirements of 5.6.4.2.	See 5.6.4.2
5.5.2.2 Endurance to weathering stress	
Polymeric materials of the module and its	Test results see subsequent
components are durable to weathering stress.	sections
5.5.2.3 Polymeric materials used as electrical insulation	
5.5.2.3.1 General	
Material relied upon for insulation are of adequate thickness, as described in Tables 3 and 4.	See Table 49 and Annex 2 (BOM)
The temperature limits of materials used as	
insulation are not less than the maximum measured operating temperature of the specific material in application, as measured during the temperature test (MST 21).	See Table 32
5.5.2.3.2 Endurance to electrical stress	
Materials used as electrical insulation are in compliance with the insulation coordination requirements	See 5.6.3
5.5.2.3.3 Endurance to thermal stress	· · · · · · · · · · · · · · · · · · ·
Materials used as relied upon insulation have a mechanical and electrical relative thermal endurance, relative thermal index or temperature index (RTE/RTI or TI) appropriate for the application, at least 90 °C.	□ TI : □ RTE : □ RTI : Assessed polymeric parts see Annex 2 (BOM) See Table 32
5.5.2.3.4 Polymeric insulating materials used as external part	

Page 20 of 84

Report No.

	External polymeric parts of the PV module meet the following requirements:						
	- flammability class minimum V-1	Assessed polymeric parts see Annex 2 (BOM)					
	<ul> <li>ball pressure test with a temperature of 75 °C</li> </ul>						
	- ignitability test in final application	See Table 37					
	- peel test of cemented joints	See Table 39					
	- lap shear strength test	See Table 40					
5.5.2.3.5 Pc	lymeric insulating parts supporting live parts	·					
	External parts of insulating material supporting live parts including connections, and parts of polymeric material providing supplementary insulation or reinforced insulation, are sufficiently resistant to heat.	Assessed polymeric parts see Annex 2 (BOM)					
	Polymeric parts which are not components of the laminate fulfil the requirements of ignitability test	Assessed polymeric parts see Annex 2 (BOM)					
		See Table 37					
	Other than elastomeric polymeric materials meet the	e following requirements:					
	- flammability class minimum HB	Assessed polymeric parts see Annex 2 (BOM)					
	<ul> <li>ball pressure test with a temperature of 125 °C</li> </ul>						
	- material creep test	See Table 13					

Page 21 of 84	Report No.
5.5.2.4 Polymeric materials used for mechanical functions	
Materials used for mechanical functions have a mechanical relative thermal endurance, relative thermal index or temperature index (RTE/RTI or TI) appropriate for the application, at least 90 °C.	□ TI : □ RTE : □ RTI : Assessed polymeric parts see Annex 2 (BOM) See Table 32
5.5.3 Metallic materials	
5.5.3.1 General Metal parts are not in contact to metal parts having a difference of their electrochemical potentials of more than 600 mV.	Assessed parts see Annex 2 (BOM)
Iron or mild steel are plated, painted, or enamelled for protection against corrosion.	
Corrosion protection is at least equivalent to a zinc coating of 0.015 mm thickness	Assessed parts see Annex 2 (BOM) See Table 6
5.5.3.2 Current carrying parts	·
Assessed parts:	See Annex 2 (BOM)
Current-carrying parts have sufficient mechanical strength and electrical conductivity.	See Table 32 See Table 34 See Table 11
Current-carrying materials are protected against corrosion.	
The coating for protective coated metal is capable of preventing corrosion according to either one of the listed standards.	□ ISO 1456 □ ISO 1461 □ ISO 2081 □ ISO 2093
Coated metal not used if the current-carrying parts are stressed by abrasion.	
5.5.4 Adhesives	
Adhesives are appropriate for the application.	See Tables 40, Table 39, Table 27, Table 29, Table 12, and Table 10
Adhesive as part of the relied upon electrical insulation meets the requirements of 5.5.2.3.3	See 5.5.2.3.3
5.6 Protection against electric shock	
5.6.1 General	
Adequate protection against contact with hazardous live parts provided	
Specimen pose no risk of electric shock.	
5.6.2 Protection against accessibility to hazardous live parts	
5.6.2.1 General	
Class of module	See safety ratings —
For class 0 and Class II modules adequate protection against accessibility to hazardous live parts (> 35 V DC) provided.	See Table 12
	· · · · · · · · · · · · · · · · · · ·

	Page 22 of 84	Кероп No.
Table 2 of 5.6.2.3	For Class 0 PV modules, accessible metal parts and accessible surfaces as well as live parts of different potential of the same circuit are separated by at least basic insulation.	
	For Class II PV modules construction provide separation between accessible parts or accessible surfaces and hazardous live parts by double or reinforced insulation.	
Table 2 of 5.6.2.3	For Class II PV modules, live parts of different potential of the same circuit are separated by double or reinforced insulation.	
	For Class III PV modules separation between accessible parts or accessible surfaces and hazardous live parts by functional insulation.	
Table 2 of 5.6.2.3	In Class III PV modules live parts of different polarity are separated by at least functional insulation.	
	Materials used for realizing protection against accessibility of hazardous live parts by means of enclosure, insulation barrier or relied upon insulation comply with the requirements of 5.5.2 due to their application.	
5.6.2.2 Pro	tection by means of enclosures and insulation ba	rriers
	Enclosures or insulation barriers are so designed that, after mounting, the live parts are not accessible (even after possible deformation)	
	Degree of protection of the housing is not impaired by any possible deformation.	
	Parts of enclosures and insulation barriers that provide protection are not removable without the use of a tool.	
	Lids which are attached without screws have one or several detectable features, e.g. recesses,	
	Tool to open the lid do not come into contact with the live parts if lid is removed correctly.	
	Insulation barrier are held in place and are not affected by influences expected during normal operation. Electrical and mechanical properties don't fall below the minimum acceptable values for the application.	
	Parts are prevented from loosening or turning.	
5.6.2.3 Pro	tection by means of insulation of live parts	
	Insulation materials providing the sole insulation between a live part and an accessible metal part, or between uninsulated live parts not of the same potential, are of adequate thickness and of a material appropriate for the application.	
	Requirements of Table 2	see 5.6.2.1 of this report —

	Page 23 01 84	кероп по.	
5.6.3 Insul	ation coordination		
5.6.3.1	Components comply with the requirements for their relevant standards	See Annex 2	
5.6.3.2	Pollution degree	See Table 1, Table 2, Table 3 -	
5.6.3.3	Material group	See Table 1, Table 2, Table 3 -	
5.6.3.4	Clearance and creepage distance	See Table 1, Table 2, Table 3, Table 4	
	Derating factor for altitude above 2000 m is considered		
5.6.4 Dista	ance through insulation (dti)		
5.6.4.1 Ge	neral		
	Polymeric materials for cemented insulation parts and insulation in thin layers shall withstand environmental, thermal, electrical and mechanical stresses as far as they occur.	See 5.5.2	
	Distances through insulation (dti) of solid insulation comply with the minimum distance as required:		
	System voltage:	See safety ratings	
	Distance through insulation req./meas. (mm):		
	The insulation fulfils the material classification as given in IEC 60216-1, IEC 60216-2 and IEC 60216-5 (RTE/TI/RTI).	See annex 2	
5.6.4.2 Ce	mented joints		
	Cemented joints were considered as	<ul> <li>Edge seal</li> <li>Interface between Junction</li> <li>Box and mounting surface</li> <li>others</li> </ul>	—
	Distances along cemented joints comply with the minimum distances as required in table 3 or table 4:		
	System voltage:	See safety ratings	_
	Distance along cemented joints req./meas. (mm):		
	A distance can be considered as cemented joint if following requirements are met:		_
	Nother greate per voide in the insulating		
	<ul> <li>Neither cracks nor voids in the insulating compounds have been occurred which either by themselves or in combination reduces the distances through the cemented joint below the required values.</li> </ul>		
	compounds have been occurred which either by themselves or in combination reduces the distances through the		
	<ul> <li>compounds have been occurred which either by themselves or in combination reduces the distances through the cemented joint below the required values.</li> <li>No breakdown at MST 16 (initial and final</li> </ul>		
	<ul> <li>compounds have been occurred which either by themselves or in combination reduces the distances through the cemented joint below the required values.</li> <li>No breakdown at MST 16 (initial and final test)with a 1,35 times higher tests voltage:</li> </ul>		

Page 24 of 84

Report No.

	Faye 24 01 04	Report No	·
	The electrically insulating adhesive/sealant have a volume resistivity:		_
	- of greater than 50 × 10 <sup>6</sup> $\Omega$ cm (dry)		
	- and greater than $10 \times 10^6 \Omega$ cm (wet).		
	<ul> <li>□ rigid / rigid: lap shear test MST 36</li> <li>□ rigid / flexible: Peel test MST 35</li> </ul>	See Table 40 and Table 39	
	Supplement information: Above mentioned tests have Also the materials and their properties have to be liste		nted joint.
5.6.4.3	Insulation in thin layers		
	Relied upon insulation in thin layers is applied at	<ul> <li>Backsheet</li> <li>Front sheet</li> <li>insulation within laminate</li> <li>others</li> </ul>	
	Initial Construction of Insulation in thin layers complies with requirements concerning thickness under consideration of figure 4 as described in table 3 or 4	See Annex 2	
	Construction of Insulation in thin layers complies with requirements concerning RTE/TI/RTI	See Annex 2	
	Insulation in thin layers provide sufficient dielectric strength:	See Annex 2	
	Test voltage for single-layer sheet and for entire multi-layer sheet providing relied upon insulation (2000V + 4 times system voltage)	See Annex 2	
	Test voltage for each layer of a multi-layer providing relied upon insulation (1000V + 2 times system voltage)	See Annex 2	
	Informative parameter evaluated according to IEC 62788-2 are presented	See Annex 2	
	Single-layer sheet as well as entire multi-layer sheet in final application comply with following:		
	<ul> <li>Minimum thickness according to lines 1b) of Table 3 and Table 4, (not less than 30µm) req./meas. (mm),:</li> </ul>	See Table 49	
	<ul> <li>Dielectric strength for basic insulation is provided after cut susceptibility test (MST 12)</li> <li>(1000V + 2 times system voltage)</li> </ul>	See Table 41	
	Test voltage (V):		

Page 25 of 84

Report No.

5.6.3.4: Clearance and creepage distances									
Table 1: Design evaluation									
Clearance (cl) and creepage	creepage 5 ins		Pollution degree	CTI Material	Working voltage		ance cl nm)	Creepage cr (mm)	
distance (cr) at/of/between:	Line of table 3			group		Requir ed	Designª	Requir ed	Design <sup>a</sup>
Position 1:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 2:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 3:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 4:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Supplementary	info	rmation see photo	ographs/dra	wings/illus	trations or	n annex x	xxx		
according to IE	C 60			clearence	which is ve	erified by	impulse vo	oltage tes	t
5.6.3.4: Clearance and creepage distances									

Table 2: PV module evaluation MST 01 initial

Sample #: 1, 4, 5, 7, 9, 13, 14, 16

Page 26 of 84 Report No.									
Clearance (cl) and creepage	3or 4	Type of insulation	Pollution degree	CTI Material	Working voltage		ance cl nm)		bage cr hm)
distance (cr) at/of/between:	Line of table 3			group		Requir ed	Meas.ª / sample #	Requir ed	Meas.ª / sample #
Position 1:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 2:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 3:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 4:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Supplementary	info	rmation see photo	ographs/dra	wings/illus	trations or	n annex x	ххх		
<sup>a</sup> Report the sm clearence whic	halles h is v	st measured dista /erified by impulse	nce and sa e voltage te	mple #. Lis st accordir	st relevant ng to IEC 6	position a	and test vo	ltage for	each

5.6.3.4: Clearance and creepage distances	
Table 3: PV module evaluation MST 01 final	
Sample #: 1, 4, 5, 7, 9, 13, 14, 16	

			Page	27 of 84			F	Report No	
Clearance (cl) and creepage	3or 4	Type of insulation	Pollution degree	degree Material voltage			ance cl ım)	Creepage cr (mm)	
distance (cr) at/of/between:	Line of table 3			group		Requir ed	Meas. <sup>a</sup>	Requir ed	Meas.
Position 1:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 2:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 3:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
Position 4:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>	□ 1 □ 2 □ 3	□ I □ II □ IIIa					
<sup>a</sup> List relevant p	<sup>a</sup> List relevant position and test voltage for each clearence which is verified by impulse voltage test according to IEC 60664-1:								

Table 4: 5.6.3.4 - Clearance evaluated by Impulse voltage test				
Test Date (YYYY-MM-DD)				
Results				
□ No evidence of dielectric breakdown or su	rface tracking observed			
Supplementary information:				

		Pa	ge 28 of 84	1			Report	No.
Clearance (cl) at/of/between:	e			Impulse voltage		Measured	ł	Verdict
Sample#	tab		Ű	Ű	Voltag	T <sub>1</sub>	T <sub>2</sub>	
	Line of table 3or 4				e Peak kV	μs	μs	
Position 1:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>						
Position		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>						
Position:		<ul> <li>Functional</li> <li>Basic</li> <li>Suppl.</li> <li>Reinforced</li> </ul>						
Supplementary info	ormatior	):	1	1	1		1	

### Page 29 of 84 IS/IEC 61730 PART 2: REQUIREMENTS FOR TESTING

## 8 Testing

#### Test sequences see IS/IEC 61730-2: 2016

Deviations from test sequence are possible but must be documented. See also table 5-

10 TEST	PROCEDURES						
10.1 General: Safety qualification testing included the following Module Safety Tests (MST) of IS/IEC 61730-2: 2016							
Initial Testing							
10.2	MST 01 – Visual inspection	See appended Table 6					
10.3	MST 02 - Performance at STC	See appended Table 7					
10.4	MST 03 – Maximum power determination:	See appended Table 8					
10.13	MST 16 – Insulation test	See appended Table 9					
10.14	MST 17 – Wet leakage current test	See appended Table 10					
10.11	MST 13 – Continuity test of equipotential bonding:	See appended Table 11					
10.9	MST 11 – Accessibility test	See appended Table 12					
Sequenc	e A	· · · · ·					
10.26	MST 37 – Materials creep test:	See appended Table 13					
10.11	MST 13 – Continuity test of equipotential bonding:	See appended Table 11					
10.9	MST 11 – Accessibility test	See appended Table 12					
Sequenc	e B	· · · · ·					
10.30	MST 53 – Damp heat test 200h	See appended Table 14					
10.31	MST 54 – UV test 60kWh/m <sup>2</sup>	See appended Table 15					
10.29	MST 52 – Humidity freeze test	See appended Table 16					
10.31	MST 54 – UV test 60kWh/m <sup>2</sup>	See appended Table 17					
10.29	MST 52 – Humidity freeze test	See appended Table 18					
Sequenc	e B1	· · · · ·					
10.32	MST 55 – Cold conditioning	See appended Table 19					
10.33	MST 56 – Dry heat conditioning	See appended Table 20					
10.29	MST 52 – Humidity freeze test	See appended Table 21					
10.32	MST 55 – Cold conditioning:	See appended Table 22					

10.29 MST 52 – Humidity freeze test .....: See appended Table 23 Sequence C 10.31 MST 54 – UV test 15kWh/m<sup>2</sup>.....: See appended Table 24 10.28 MST 51 – Thermal cycling 50 test .....: See appended Table 25 10.29 MST 52 – Humidity freeze test .....: See appended Table 26 10.27 MST 42 – Robustness of terminations test.....: See appended Table 27 Sequence D 10.30 MST 53 – Damp heat test .....: See appended Table 28 10.23 See appended Table 29 MST 34 – Static mechanical load test ..... Sequence E 10.28 See appended Table 30 MST 51 – Thermal cycling 200 test .....: Sequence F 10.19 See appended Table 31 MST 25 – Bypass diode thermal test.....: 10.15 MST 21 – Temperature Test..... See appended Table 32 10.16 MST 22 – Hot-spot endurance Test..... See appended Table 33 10.20 See appended Table 34 MST 26 – Reverse current overload test .....: Sequence G 10.12 MST 14 – Impulse voltage test .....: See appended Table 35 Other tests 10.17 MST 23 – Fire Test ..... See appended Table 36 10.18 MST 24 – Ignitability test ..... See appended Table 37 10.21 MST 32 – Module breakage test.....: See appended Table 38 10.24 See appended Table 39 MST 35 – Peel test ..... 10.25 MST 36 – Lap shear strength test .....: See appended Table 40 **Final Testing** 10.10 MST 12 - Cut susceptibility test .....: See appended Table 41 10.11 MST 13 - Continuity test of equipotential bonding: See appended Table 11 10.9 See appended Table 12 MST 11 – Accessibility test ..... 10.4 See appended Table 42 MST 03 – Maximum power determination .....:

Page 30 of 84

Report No.

Page 31 of 84

Report No.

	5	•					
10.1	MST 01 – Visual inspection	See appended Table 43					
10.6	MST 05 – Durability of markings	See appended Table 44					
10.7	MST 06 – Sharp edge test	See appended Table 45					
10.8	MST 07 – Bypass diode functionality test	See appended Table 46					
10.22	MST 33a – General screw connections test:	See appended Table 47					
10.22	MST 33b – Locking Screw connections test:	See appended Table 48					
10.5	MST 04 – Insulation thickness test	See appended Table 49					
Supplementary information:							

Page 32	of 84	
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Table 5: Overview of MST items for each t	est sa	amp	le										
MST item						S	amp	le No	Э.				-
	-	4	5	7	6	13	14	15	16	17	18	19	
Control module	Х												
MST 01 – Visual inspection	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	
MST 02 – Performance at STC	Х												
MST 03 – Maximum power determination		Х	Х	Х	Х	Х	Х	Х	Х				
MST 04 – Insulation thickness test							Х						
MST 05 – Durability of markings	Х	Х	Х	Х	Х		Х	Х					
MST 06 – Sharp edge test	Х	Х	Х	Х	Х		Х	Х					
MST 07 – Bypass diode functionality test	Х	Х	Х	Х	Х		Х	Х					
MST 11 – Accessibility test			Х	Х	Х	Х	Х	Х					
MST 12 – Cut susceptibility test			Х	Х	Х		Х	Х					T
MST 13 – Continuity test of equipotential			Х	Х	Х	Х	Х	Х	-	-	Х		
bonding									V				$\vdash$
MST 14 – Impulse voltage test		V	V	V	V	V	V	V	X				╞
MST 16 – Insulation test		X	X	X	X	X	X	X	Х				╞
MST 17 – Wet leakage current test		X	Х	Х	Х	Х	Х	Х					
MST 21 – Temperature Test		X											
MST 22 – Hot-spot endurance Test		Х											
MST 23 – Fire Test													
MST 24 – Ignitability test										Х			
MST 25 – Bypass diode thermal test		Х											
MST 26 – Reverse current overload test		Х											
MST 32 – Module breakage test											Х		
MST 33 – Screw connections test	Х	Х	Х	Х	Х								
MST 34 – Static mechanical load test					Х								
MST 35 – Peel test												Х	L
MST 36 – Lap shear strength test:													L
MST 37 – Materials creep test:						Х							
MST 42 – Robustness of terminations test			Х										
MST 51 – Thermal cycling test 50			Х										
MST 51 - Thermal cycling test 200				Х									L
MST 52 – Humidity freeze test			Х				Х	Х					L
MST 53 – Damp heat test 200 h							Х						
MST 53 – Damp heat test 1000 h					Х								
MST 54 – UV test 15 KWh/m <sup>2</sup>			Х										
MST 54 – UV test 60 KWh/m²							Х						
MST 55 – Cold conditioning								Х					
MST 56 – Dry heat conditioning								Х					
Legend:													

Page 33 of 84

Report No.

Table 6: MST 01 - Initial Visual inspection							
Test Date (	YYYY-MM-DD):		—				
Sample #	Findings:	□ Yes□ No					
1 1	Nature and position of findings – comments or attach photos		—				
Sample #	Findings	□ Yes□ No					
4	Nature and position of findings – comments or attach photos		—				
Sample #	Findings	□ Yes□ No					
5	Nature and position of findings – comments or attach photos		—				
Sample #	Findings	□ Yes□ No					
6	Nature and position of findings – comments or attach photos		—				
Sample # 9	Findings	□ Yes□ No					
	Nature and position of findings – comments or attach photos		—				
Sample # 13	Findings	□ Yes□ No					
	Nature and position of findings – comments or attach photos		—				
Sample #	Findings	□ Yes□ No					
14	Nature and position of findings – comments or attach photos		—				
Sample #	Findings	□ Yes□ No					
15	Nature and position of findings – comments or attach photos		—				
Sample #	Findings	□ Yes□ No					
16	Nature and position of findings – comments or attach photos		—				
Sample #	Findings	□ Yes□ No					
17	Nature and position of findings – comments or attach photos		—				
Sampla #	Findings	□ Yes□ No					
Sample # 18	Nature and position of findings – comments or attach photos						
Sample # 19	Findings:	□ Yes□ No					
Supplemen	tary information: For creepage distan	ces and clearances see Table 1, Table 2, Table 3 and Ta	ble 4				

Page 34 of 84

Report No.

Table 7: MST (	2 - Performanc	e at STC				
Sample						_
:						
Test Date [YYYY-MM-DD]						—
:						
Irradiance (W/m2)			1000			—
:						
Module temperature (°C)			25			—
:						
Test method			□ Simulator □	Natural sunlight		—
:						
Rated Isc inclu	ding manufactur	ing tolerances				—
:						
Rated Voc including manufacturing tolerances						_
:						
lsc [A]	Voc [V]	Imp [A]	Vmp [V]	Pmp [W]	FF [%]	Result
Supplementary	information:					

Table 8: MST 03 - Maximum power determination								
Test Date [YYYY-MM-DD]							—	
:								
Irradiance (W/m2)			1000				_	
:								
Module temperature (°C)			25				—	
:								
Test metho	d			□ Simulator □ Natural sunlight				
:								
Sample #	lsc [A]	Voc [V]	Imp	[A]	Vmp [V]	Pmp [W]	FF [%]	Result
4								
5								
7								
9								

Page 35 of 84

Report No.

13									
14									
15									
16									
Supplemen	Supplementary information:								

Page 36 of 84

Report No.

Table 9: MS	ST 16 - Initial Insu	ulation test		
	YYYY-MM-DD)			-
:				
Test Voltage applied (V, DC)				—
Sample #	Measured	Required	Dielectric breakdown	Result
	MΩ	MΩ	Yes (description) No	
4				
5				
7				
9				
13				
14				
15				
16				
Supplement	ary information: S	Size of module [m <sup>2</sup> ]	· · · · · · · · · · · · · · · · · · ·	

Table 10: MST 17 - Initial Wet leakage current test								
Test Date (	(YYY-MM-DD)		—					
:								
Test Voltage applied (V, dc)			—					
Solution resistivity (Ω cm)		< 3500 Ω cm at 22 ± 2°C	_					
:								
Solution ten	nperature (°C)		_					
:								
Sample #	Measured (MΩ)	Required (MΩ)	Result					
4								
5								
7								
9								
13								
14								
15								
Supplement	ary information: Size of module [m <sup>2</sup> ]							
Page 37 of 84

Report No.

Table 11: N	IST 13 - Continuity test of equipotential bonding				
Test Date Ir	nitial examination (YYYY-MM-DD)			_	
:					
Test Date F	inal examination (YYYY-MM-DD)			_	
:					
Maximum c	Maximum over-current protection rating (A):				
Current app	blied (A):				
Location of designated grounding point					
Location of	second contacting point			_	
Sample #	Position in test sequence:	Voltage [V]	Resistance [ $\Omega$ ]		
5	Initial examination				
	Preconditioning: MST 54, MST 51, MST 52, MST 42, MST 12				
	Final examination				
7	Initial examination				
	Preconditioning: MST 51, MST 12				
	Final examination				
9	Initial examination				
	Preconditioning: MST 53, MST 34, MST 12				
	Final examination				
13	Initial examination				
	Preconditioning: MST 37				
	Final examination				
14	Initial examination				
	Preconditioning: MST 53, MST 54, MST 52, MST 54, MST 52, MST 12				
	Final examination				
15	Initial examination				
	Preconditioning: MST 55, MST 56, MST 52, MST 55, MST 52, MST12				
	Final examination				
18	Initial examination				
	Preconditioning: MST 32				
	Final examination				
Supplemen	tary information:				

Table 12: N	IST 11 - Accessibility test		
Test Date I	nitial examination (YYYY-MM-DD):		_
Test Date F	inal examination (YYYY-MM-DD):		—
Sample #	Position in test sequence:		
5	Initial examination, access?	□ Yes □ No	
	Preconditioning: MST 54, MST 51, MST 52, MST 42, MST 12, MST 13		
	Final examination, access?	□ Yes □ No	
7	Initial examination, access?	□ Yes □ No	
	Preconditioning: MST 51, MST 12, MST 13		
	Final examination, access?	□ Yes □ No	
9	Initial examination, access?	🗆 Yes 🗆 No	
	Preconditioning: MST 53, MST 34, MST 12, MST 13		
	Final examination, access?	□ Yes □ No	
13	Initial examination, access?	□ Yes □ No	
	Preconditioning: MST 37, MST 13		
	Final examination, access?	🗆 Yes 🗆 No	
14	Initial examination, access?	□ Yes □ No	
	Preconditioning: MST 53, MST 54, MST 52, MST 54, MST 52, MST 12, MST 13		
	Final examination, access?	□ Yes □ No	
15	Initial examination, access?	□ Yes □ No	
	Preconditioning: MST 55, MST 56, MST 52, MST 55, MST 52, MST12		
	Final examination, access?	□ Yes □ No	
Supplemen	tary information:		

Page 40 of 84

Report No.

		SEQUENCE A		
Sample # 13				—
Table 13: MST 37 - Ma	terials creep test			
Test Date (YYYY-MM-D	D) start/end			-
Duration [h]		200		
Applied temperature [°C	]:			
MST 01: Visual inspec	ction after materials cree	ep test		
Test Date (YYYY-MM-D	DD):			
Findings	:	□ Yes□ No		
Nature and position of findings – comments or attach photos				—
Supplementary information: For clearance and creepage distances see table XYZ				
MST 16: Insulation test after materials creep test		-		
Test Date (YYY-MM-DD)				_
Test Voltage applied (V	, dc):			_
Measured	Required	Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	
MST 17: Wet leakage of	current test after materia	als creep test		—
Test Date (YYYY-MM-D	DD):			-
Test Voltage applied (V	, dc):			—
Solution resistivity ( $\Omega$ cm) < 3500 $\Omega$ cm at 22 ± 2		< 3500 $\Omega$ cm at 22 $\pm$ 2°C		-
Solution temperature (°C):				
Measu	red(MΩ)	Required (MΩ)		Result
Supplementary informat	tion:			

Page 41 of 84

Report No.

## SEQUENCE B

Sample # 14				_
Table 14: MST 53 - D	Damp heat test			
Test Date (YYYY-MM	I-DD) start/end			
Duration [h]		200		_
MST 01: Visual insp	MST 01: Visual inspection after Damp heat test			—
Test Date (YYYY-MM-DD):			—	
Findings:		□ Yes□ No		
Nature and position of findings – comments or attach photos				—
MST 16: Insulation t	est after Damp heat test			_
Test Date (YYYY-MM	I-DD):			—
Test Voltage applied	(V, DC):			—
Measured	Required	Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	
Supplementary information:				

Table 15: MST 54 - U	JV test			
Test Date (YYYY-MN	I-DD) start/end:			—
Module temperature [	[°C]	60		—
Irradiation total [kWh/	m²]:	60		—
Open circuits	:	🗆 Yes 🗆 No		
MST 01: Visual insp	ection after UV test			_
Test Date (YYYY-MN	I-DD):			_
Findings	:	□ Yes□ No		
Nature and position of findings – comments or attach photos				—
MST 16: Insulation t	est after UV test			_
Test Date (YYYY-MN	I-DD):			_
Test Voltage applied	(V, DC):			—
Measured Required		Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	
Supplementary inform	nation:			

Page 42 of 84

Report No.

Table 16: MST 52 -H	umidity freeze test			
Test Date (YYYY-MM	1-DD) start/end:			—
Total cycles (10)	:	10		—
Open circuits	:	□ Yes □ No		
MST 01: Visual insp	ection after Humidity freez	ze test		_
Test Date (YYYY-MM	1-DD):			_
Findings	:	□ Yes□ No		
Nature and position or attach photos	of findings – comments or			_
MST 16: Insulation test after Humidity freeze test				—
Test Date (YYYY-MN	1-DD):			_
Test Voltage applied	(V, DC):			_
Measured	Required	Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	
Supplementary inform	nation:			
Table 17: MST 54 - U				
-	1-DD) start/end	60		
	[°C] [m²]			
	·····			
-				
MST 01: Visual insp				
· · ·	1-DD):			
	······:	□ Yes□ No		
Nature and position of attach photos	of findings – comments or			
MST 16: Insulation test after UV test				
Test Date (YYYY-MN	1-DD):			
Test Voltage applied	(V, DC)			

Table 18: MST 52 - Humidity freeze test	
Test Date (YYYY-MM-DD) start/end:	

	Pa	ge 43 of 84 Report No.	
Total cycles (10)	:	10	—
	·······		
MST 01: Visual inspection after Humidity free		ze test	_
Test Date (YYYY-MM-DD):			—
Findings	:	□ Yes□ No	
Nature and position of findings – comments or attach photos			—
MST 16: Insulation t	est after Humidity freeze t	est	—
Test Date (YYYY-MM-DD)			—
Test Voltage applied (V, DC)			—
Measured	Required	Dielectric breakdown	Result
MΩ	ΜΩ	Yes (description) No	
MST 17: Wet leakag	e current test after humid	ity freeze 10 test	—
Test Date (YYYY-MN	I-DD):		_
Test Voltage applied	(V, dc):		—
Solution resistivity ( $\Omega$	cm):	< 3500 $\Omega$ cm at 22 $\pm$ 2°C	_
Solution temperature (°C):			_
Measured (MΩ)		Required (MΩ)	Result
Supplementary inform	nation:		

Page 44 of 84

Report No.

		SEQUENCE B1		
Sample #				_
Table 19: MST 55 - Co	Id conditioning			
Test Date (YYYY-MM-I	DD) start/end			
Temperature [°C] Dura	ion [h]	-40 / 48		_
MST 01: Visual inspec	tion after Cold condition	ning		
Test Date (YYYY-MM-I	DD):			
Findings:		□ Yes□ No		
Nature and position of findings – comments or attach photos				_
MST 16: Insulation tes	at after Cold conditioning	9		_
Test Date (YYYY-MM-I	DD):			
Test Voltage applied (V, DC)				_
Measured	Required	Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	

Supplementary information: --

Table 20: MST 56 - Dry heat conditioning				
Test Date (YYYY-MM-D	D) start/end:			
Temperature [°C] Durat	Temperature [°C] Duration [h]:			
MST 01: Visual inspection after Dry heat conditioning				
Test Date (YYYY-MM-D	D):			_
Findings	:	□ Yes□ No		
Nature and position of findings – comments or attach photos				-
MST 16: Insulation test	after Dry heat conditio	ning		_
Test Date (YYYY-MM-D	D):			_
Test Voltage applied (V,	DC):			_
Measured	Required	Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	
Supplementary informati	on:			

Table 21: MST 52 - Humidity freeze test			
Test Date (YYYY-MM-DD) start/end			
Total cycles (10):	10		

	Pa	ge 45 of 8	34	Report No.	
Open circuits	:	□ Yes	□ No		
MST 01: Visual inspect	ion after Humidity freez	e test			_
Test Date (YYYY-MM-DI	D):				_
Findings	:		□ Yes□ N	No	
Nature and position of fin attach photos	ndings – comments or				_
MST 16: Insulation test	after Humidity freeze to	est			_
Test Date (YYYY-MM-DI	D):				_
Test Voltage applied (V,	DC)				_
Measured	Required		Dielectric breakdown		Result
ΜΩ	ΜΩ		Yes (description)	No	
Supplementary information	on:				

Supplementary information:

Table 22: MST 55 - Cold conditioning					
Test Date (YYYY-MM-DD) start/end:				_	
Temperature [°C] / Dura	tion [h]:	-40 / 48		_	
MST 01: Visual inspect	MST 01: Visual inspection after Cold conditioning			_	
Test Date (YYYY-MM-D	D):			_	
Findings:		□ Yes□ No			
Nature and position of findings – comments or attach photos				_	
MST 16: Insulation test	after Cold conditioning	9		_	
Test Date (YYYY-MM-D	D):			_	
Test Voltage applied (V,	DC)			_	
Measured	Required	Dielectric breakdown		Result	
ΜΩ	MΩ	Yes (description)	No		
Supplementary information:					

Table 23: MST 52 - Humidity freeze test					
Test Date (YYYY-MM-DD) start/end:		—			
Total cycles (10)	10	—			
Open circuits:	□ Yes □ No				
MST 01: Visual inspection after Humidity freeze test					
Test Date (YYYY-MM-DD):		_			
Findings	□ Yes□ No				

dings – comments or			—
after Humidity freeze t	est		_
)):			_
DC)			_
Required	Dielectric breakdown		Result
MΩ	Yes (description)	No	
rrent test after humidi	ty freeze test		
):			—
lc):			_
:	< 3500 $\Omega$ cm at 22 $\pm$ 2°C		—
:			
d (MΩ)	Required (MΩ)		Result
n:	·		
	after Humidity freeze t         i)         i)         DC)         Required         MΩ         rrent test after humidi         i)         ic)         ic)	after Humidity freeze test         after Humidity freeze test         a)	after Humidity freeze test         after Humidity freeze test         a)         DC)         DC)         Required         Dielectric breakdown         MQ         Yes (description)         No         rrent test after humidity freeze test         )         dc)         < 3500 $\Omega$ cm at $22 \pm 2^{\circ}$ C            d (MQ)         Required (MQ)

Page 47 of 84

Report No.

# SEQUENCE C

Sample #				
Table 24: MST 54 - UV t				
Test Date (YYYY-MM-DI	D) start/end:			_
Module temperature [°C]	:	60		
Irradiation total [kWh/ m <sup>2</sup> ]	:	15		_
Open circuits	:	□ Yes □ No		
MST 01: Visual inspect	ion after UV test			
Test Date (YYYY-MM-DI	D):			
Findings:		□ Yes□ No		
Nature and position of findings – comments or attach photos				-
MST 16: Insulation test	after UV test			_
Test Date (YYYY-MM-DI	D):			
Test Voltage applied (V, DC)				—
Measured	Required	Dielectric breakdown		
ΜΩ	MΩ	Yes (description)	No	
Supplementary information	on:			

Table 25: MST 51 - Thermal c	ycling test			
Test Date (YYYY-MM-DD) star	t/end:			_
Total cycles (50)	:	50		
Applied current (A)	:			
Limiting voltage (V)	:			—
Open circuits	:	□ Yes □ No		
MST 01: Visual inspection aft	ter Thermal cyclir	ng test		_
Test Date (YYY-MM-DD):				_
Findings:		□ Yes□ No		
Nature and position of findings – comments or attach photos				—
MST 16: Insulation test after	Thermal cycling t	test		_
Test Date (YYYY-MM-DD)	:			_
Test Voltage applied (V, DC):				
Measured Required		Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	

Page 48 of 84

Report No.

Supplementary information:						
Table 26: MST 52 - Humic	dity freeze test					
Test Date (YYYY-MM-DD) start/end				-		
Total cycles (10)	:	10		-		
Open circuits	:	□ Yes □ No				
MST 01: Visual inspectio	n after Humidity freez	ze test		_		
Test Date (YYYY-MM-DD)	:			—		
Findings	:	□ Yes□ No				
Nature and position of findings – comments or attach photos				—		
MST 16: Insulation test after Humidity freeze t		est		—		
Test Date (YYYY-MM-DD)	:			—		
Test Voltage applied (V, DC)				-		
Measured	Required	Dielectric breakdown		Result		
MΩ	MΩ	Yes (description)	No			
MST 17: Wet leakage cur	rent test after humidi	ty freeze test				
Test Date (YYYY-MM-DD)	:					
Test Voltage applied (V, do	;):			—		
Solution resistivity (Ω cm):		< 3500 $\Omega$ cm at 22 $\pm$ 2°C		_		
Solution temperature (°C)				—		
Measured (MΩ)		Required (MΩ)		Result		
Supplementary information	1:					

Table 27: MST 42 - Robustness of terminations test						
Test Date (YYY-MM-DD):		—				
MQT 14.1: Retention of junction box on mount	ting surface					
Supplementary information:	Supplementary information:					
MST 01: Visual inspection after retention of ju	nction box on mounting surface					
Test Date (YYY-MM-DD):		—				
Findings	□ Yes□ No					
Nature and position of findings – comments or attach photos						
MST 17: Wet leakage current test after retention of junction box on mounting surface						
Test Date (YYY-MM-DD):		—				
Test Voltage applied [V]		_				

Pa	ge 49 of 84	Report No.		
Solution resistivity ( $\Omega$ cm)	< 3500 $\Omega$ cm at 22 $\pm$ 2°C		—	
Solution temperature (°C)			—	
Measured [MΩ]	Required [MΩ]		Result	
Supplementary information:				

Page 50 of 84

Report No.

SEQUENCE D					
Sample #					_
Table 28: MST	53 - Dam	p heat test			
Test Date (YYY	Y-MM-DD	)) start/end:			_
Total hours (100	)0)	:	1000		_
MST 01: Visual	inspecti	on after damp heat tes	t		_
Test Date (YYY	Y-MM-DD	)):			—
Findings		:	□ Yes□ No		
Nature and position of findings – comments or attach photos		idings – comments or			_
MST 16: Insula	MST 16: Insulation test after damp heat test		-		
Test Date (YYY	Y-MM-DD	):			
Test Voltage ap	plied (V, I	C)			
Measure	d	Required	Dielectric breakdown		Result
MΩ		MΩ	Yes (description)	No	
MST 17: Wet le	akage cu	irrent test after damp l	neat test		
Test Date (YYY)	Y-MM-DD	):			—
Test Voltage ap	plied (V, o	dc):			
Solution resistivi	Solution resistivity ( $\Omega$ cm)		< 3500 $\Omega$ cm at 22 $\pm$ 2°C		
Solution temperature (°C)		):			—
	Measure	d (MΩ)	Required (MΩ)		Result
Supplementary	informatio	on:			

Table 29: MST 34 - Static mechanical load test					
Test Date (YYYY-MM-DD):			_		
Mounting method			—		
Design Load [Pa] / Safety factor ɣm:			—		
Load applied to	front side	back side	—		
Mechanical load [Pa]			—		
First cycle time (start/end):	1h	1h	—		
Intermittent open-circuit (yes/no):	No	No			
Second cycle time (start/end):	1h	1h	—		
Intermittent open-circuit (yes/no):	No	No			
Third cycle time (start/end):	1h	1h	—		
Intermittent open-circuit (yes/no):	No	No			

Page 51 of 84

Supplementary infor	mation: Maximum bending at	t module centre xx mm.		
MST 01: Visual inspection after Static mechanical load test				
Test Date (YYYY-M	M-DD):			—
Findings	:	□ Yes□ No		
Nature and position attach photos	of findings – comments or			—
MST 16: Insulation	test after Static mechanica	I load test		—
Test Date (YYYY-M	M-DD):			—
Test Voltage applied	d (V, DC):			_
Measured	Required	Dielectric breakdown		Result
MΩ	ΜΩ	Yes (description)	No	
MST 17: Wet leakag	ge current test after Static	mechanical load test		—
Test Date (YYYY-M	M-DD):			—
Test Voltage applied	d (V, dc):			_
Solution resistivity (	Ω cm):	< 3500 $\Omega$ cm at 22 $\pm$ 2°C		—
Solution temperature (°C):				_
Measured (MΩ)		Required (MΩ)		Result
Supplementary infor	mation:			

Page 52 of 84

Report No.

		SEQUENCE E		
Sample # 9				_
Table 30: MST 51 - The	rmal cycling test			
Test Date (YYYY-MM-D	D) start/end:			_
Total cycles (200):		200		_
Applied current (A)				_
Limiting voltage (V)	:			—
Open circuits	:	□ Yes □ No		
MST 01: Visual inspect	ion after Thermal cyclir	ng test		_
Test Date (YYYY-MM-D	D):			_
Findings	:	□ Yes□ No		
Nature and position of findings – comments or attach photos				_
MST 16: Insulation test after Thermal cycling test				—
Test Date (YYYY-MM-DD)				—
Test Voltage applied (V, DC):				—
Measured	Required	Dielectric breakdown		Result
MΩ	ΜΩ	Yes (description)	No	
MST 17: Wet leakage c	urrent test after Therma	al cycling test		
Test Date (YYYY-MM-D	D):			
Test Voltage applied (V,	dc):			
Solution resistivity (Ω cm):		< 3500 $\Omega$ cm at 22 $\pm$ 2°C		—
Solution temperature (°C):				—
Measure	ed (MΩ)	Required (MΩ)		Result
Supplementary informati	on:			

	SEQUENCE F	-		-	
Sample # 4					
Table 31: MST 25 - Bypass diode thermal test					
Test Date [YYY-MM-DD] start/end:					
Module temperature [°C]:					
Number of diodes in junction box					_
Diode manufacturer:					—
Diode type designation					—
Max. permissible junction temperature Tjmax [°C] (according to diode datasheet)					—
Step 1, Determination of VD versus TJ charac	teristic				_
Ambient temperature of the junction box [°C]:	30 ± 2	50 ± 2	70 ± 2	90 ± 2	—
Pulsed current					—
Voltage drop [V]					—
VD versus TJ characteristic					
Max. permissible junction temperature Tj <sub>max</sub> [°C] (according to diode datasheet)					
Step 2, Bypass diode thermal test					
	Diode 1	Dio	de 2	Diode 3	Result
Current flow applied [A] Max. diode surface temperature allowed Tjmax [°C],					-
Voltage drop [V] after 1h					
Calculated max. junction temperature Tjcalc [°C]					
Tjcalc < Tjmax (test passed)? yes/no					
Current flow (1.25 * Isc) [A]					
Bypass diode remain(s) functional (yes/no):					
Remarks: See Table 46 for the test details of bypa	ass diode funct	ionality test			
MST 01: Visual inspection after Bypass diode	thermal test				
Test Date [YYY-MM-DD]:					
Findings:		□ Yes	N	No	
Nature and position of findings – comments or attach photos					_

TRF No. IS/IEC61730-1:2016 IS/IEC61730-2:2016

Page 54 of 84

Report No.

MST 16: Insulation test after Bypass diode thermal test				
Test Date (YYYY-MM-D	DD):			—
Test Voltage applied (V, DC)				—
Measured	Required	Dielectric breakdown		Result
MΩ	MΩ	Yes (description)	No	
MST 17: Wet leakage current test after Bypass diode thermal test			_	
Test Date [YYYY-MM-DD]:				—
Test Voltage applied [V]:				—
Solution resistivity [ $\Omega$ cm):		< 3500 $\Omega$ cm at 22 $\pm$ 2°C		_
Solution temperature [°C]				_
Measured [MΩ] Required [MΩ]				Result
Supplementary information	tion:			

Table 32: MST 21 - Temperature Test				
Reference solar irradiance (W/m²)	1000 W/m <sup>2</sup>			
Reference ambient temperature (°C)				
	Module at MPP			
Measuring location:	Component temperature T <sub>OBS</sub> (°C)	Normalized temperature T <sub>CON</sub> (°C)	Component temperature limit (°C)	
PV module frontsheet above the centre cell				
PV module backsheet below the centre cell				
Terminal enclosure interior surface				
Field wiring terminals				
Insulation of the field wiring leads				
External connector bodies				
Bypass diode bodies				
MST 01: Visual inspection after Temperature T	Test			
Test Date (YYY-MM-DD)				—
Findings		Yes	🗆 No	
Nature and position of findings – comments or attach photos				_
MST 16: Insulation test after Temperature Tes	t			
Test Date (YYY-MM-DD)				
Test Voltage applied (V, DC)				

Page 55 of 84

Report No.

Measured	Required	Dielectric breakdown		Result
MΩ	ΜΩ	Yes (description)	No	
MST 17: Wet lea	kage current test after Tempe	rature Test		_
Test Date (YYYY	-MM-DD):			_
Test Voltage appl	lied (V, dc):			—
Solution resistivity	γ (Ω cm):	< 3500 $\Omega$ cm at 22 $\pm$ 2°C		—
Solution temperat	ture (°C)			_
Ν	leasured (MΩ)	Required (MΩ)		Result
Supplementary in	formation:			

Table 33: MST 22 - Hot-spot endurance test		
Test Date (YYYY-MM-DD) start/end:		_
Cell interconnection circuit:		
Irradiance during each cycle		_
Module temperature at thermal equilibrium in each cycle [°C]		—
Determination of worst case cell		_
Maximum measured cell temperature in each cycle [°C]:		—
Shading rate [%] or number of cells shaded:		
Test hours for each cycle		_
MST 01: Visual inspection after hot-spot endu	rance test	_
Test Date (YYYY-MM-DD):		_
Findings	□ Yes□ No	
Nature and position of findings – comments or attach photos		

Page	56	of	84
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MST 02: Maximum	power determ	ination after	hot-spo	t endurance test			—
Test Date [YYYY-MM	1-DD]	:					_
Module temperature	[°C]	:					_
Irradiance [W/m²]		:					_
Isc [A]	Voc [V]	lmp [	[A]	Vmp [V]	Pmp [W]		FF [%]
MST 16: Insulation t	test after hot-s	pot enduran	ice test				_
Test Date (YYYY-MM	/I-DD)	:					—
Test Voltage applied	[V]	:					_
Measured	Req	uired	Dielectric breakdown			Result	
ΜΩ	M	Ω	Yes (description) No		No		
MST 17: Wet leakag	e current test	after hot-spo	ot endura	ance test			_
Test Date (YYYY-MM	/I-DD)	:					—
Test Voltage applied	[V]	:					—
Solution resistivity [ $\Omega$	cm)	:	< 3500 0	Ω cm at 22 $\pm$ 2°C			—
Solution temperature	[°C]	:					—
Mea	sured [MΩ]			Required	[ΜΩ]		Result
Supplementary inform	nation:						

Table 34: MST 26 - Reverse current overload to	est	
Test Date (YYYY-MM-DD):		—
Module over-current protection rating (A):		
Test current (A):		
Range of applied voltage (V)		
Test duration:	2 hours	
Observations		Result
No flaming of the module		
No flaming or charring of the cheesecloth		
No flaming of the tissue paper		
□ MST 17 requirements fulfilled (see appende	ed Table MST17)	
Supplementary information: Max. measured tem	perature: xx°C	
MST 01: Visual inspection after Reverse current overload test		
Test Date (YYY-MM-DD)		—
Findings	□ Yes□ No	

Page 57 of 84	/ 01 84	•
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Nature and position of attach photos	findings – comments or		—
MST 16: Insulation tes	at after Reverse current	overload test	—
Test Date (YYYY-MM-D	DD):		_
Test Voltage applied (V, DC):			_
Measured	Required	Dielectric breakdown	Result
MΩ	MΩ	Yes (description) N	0
MST 17: Wet leakage	current test after Revers	se current overload test	
Test Date (YYYY-MM-D	DD):		
Test Voltage applied (V, dc):			
Solution resistivity (Ω cm):		< 3500 $\Omega$ cm at 22 ± 2°C	—
Solution temperature (°C):		23	
Measured (MΩ)		Required (MΩ)	Result
Supplementary informa	tion:		

Page 58 of 84

Report No.

		SEQUENCE G	
Sample #: 16			_
Table 35: MST 14 - Impu	ulse voltage test		
Test Date (YYYY-MM-D	D):		_
Maximum system voltag	e (V):		
Required Impulse voltag	e (V):		
Measured Impulse voltag	ge (V):		
T₁ (μs)	:		
T₂ (μs)	:		
Thickness of conductive	foil (mm)		
Results			
□ No evidence of dielec	tric breakdown or surfac	ce tracking observed	
□ No evidence of major	visual defects (see tabl	e MST 01 below)	
MST 01: Visual inspect	ion after Impulse volta	ge test	—
Test Date (YYYY-MM-D	D):		_
Findings	:	□ Yes□ No	
Nature and position of findings – comments or attach photos			
MST 16: Insulation test	after Impulse voltage	test	_
Test Date (YYYY-MM-DI	D):		—
Test Voltage applied (V,	DC)		_
Measured	Required	Dielectric breakdown	Result
MΩ	MΩ	Yes (description) N	lo
Supplementary information	on:		

Page 59 of 84

Report No.

# OTHER TESTS Sample #: — Table 36: MST 23 - Fire test — Test Date (YYYY-MM-DD)......: — Module fire resistance class (A, B, C)......: — No. of modules provided to create the test assembly.......: — The module complies with the requirements for the fire resistance class — Supplementary information: —

Sample #: 17		_
Table 37: MST 24 - Ignitability test		
Test Date (YYYY-MM-DD)		_
Flame application point		—
Surface exposure:	□ Yes □ No	_
Backsheet foil exposure	□ Yes □ No	—
Frame adhesive exposure	□ Yes □ No	—
Edge exposure:	□ Yes □ No	_
Junction box adhesive exposure	□ Yes □ No	_
Type label exposure	□ Yes □ No	_
Backrail adhesive exposure	□ Yes □ No	—
Ignition occurs:	□ Yes □ No	—
Flame spread less as 150 mm	□ Yes □ No	
Length of destroyed area		
Supplementary information:		

Sample #: 18					
Table 38: MST 32 - Module breakage test					
Test Date (YYYY-MM-DD):		—			
Weight of impactor (kg)	45				
Thickness of sample (mm)					
Mounting technique used					
Module breakage	□ No breakage				
	<ul> <li>No separation from frame or mounting structure</li> </ul>				

	Page 60 of 84	Report No.	
		Breakage occurred, no shear or opening large enough for a 76 mm diameter sphere to pass freely developed	
		Breakage occurred, no particles larger than 65 cm <sup>2</sup> ejected from sample	
		Continuity of equipotential bonding provided, see table 10.11	
Nature and position of findings - comments of	or attach photo	S	Result
			Р
Supplementary information:			

Sample #: 14, 19							
Table 39: MST 35 - Peel test (only for cemente	d joints)						1
Test Date (YYY-MM-DD):							_
Location	Flexible From	tshe	et				_
	Flexible Back	kshe	et				
	Rigid Frontsh	neet					
	Rigid Backsh	neet					
	□ Other areas						
Width of cemented joint	□ ≤ 10 mm						-
	□ > 10mm						
Description of area				J	B		_
Arithmetic mean M1 of adhesion force of unconditioned samples [N]							_
Arithmetic mean M2 of adhesion force of samples conditioned with sequence B [N]							 —
Loss of adhesion force: $0.5 < \frac{\sum_{1}^{n} M2}{\sum_{1}^{n} M1}$							
Supplementary information:							

Sample #:		
Table 40: MST 36 - Lap shear strength test (on	ly for cemented joints)	
Test Date (YYYY-MM-DD):		—
Preconditioning:		
MST 53 Test Date (YYYY-MM-DD) start/end:		
MST 54 Test Date (YYYY-MM-DD) start/end:		_
MST 52 Test Date (YYYY-MM-DD) start/end:		_
MST 54 Test Date (YYYY-MM-DD) start/end:		_
MST 52 Test Date (YYYY-MM-DD) start/end:		_
Arithmetic mean M1 of adhesion force of unconditioned samples [N]		—
Arithmetic mean M2 of adhesion force of samples conditioned with sequence B [N]		_
Loss of adhesion force: $0.5 < \frac{\sum_{1}^{n} M2}{\sum_{1}^{n} M1}$		
Supplementary information:		

Supplementary information:

Table 41: M	IST 12 - Cut susceptibility test		
Test Date (	YYYY-MM-DD)		_
Applied for	ce (N):	8,9	—
MST 01 Vis	sual inspection after cut test		—
Test Date (	YYYY-MM-DD)		—
Sampla #	Findings	□ Yes□ No	
Sample # 5	Nature and position of findings – comments or attach photos		—
Sampla #	Findings	□ Yes□ No	
Sample # 7	Nature and position of findings – comments or attach photos		—
Sampla #	Findings	□ Yes□ No	
Sample # 9	Nature and position of findings – comments or attach photos		—
Sample #	Findings	□ Yes□ No	
Sample # 14	Nature and position of findings – comments or attach photos		_
Sample #	Findings:	□ Yes□ No	
15	Nature and position of findings – comments or attach photos		—
MST 16: In	sulation test after cut test		_
Test Date (	YYYY-MM-DD):		_

Page 62 of 84

Report No.

Test Voltage applied (V, DC):		:		_	
Sample #	Measured	Required	Dielectric breakdown		
	MΩ	MΩ	Yes (description) No		
5					
7					
9					
14					
15					

MST 17: Wet leakage current test after cut test				
Test Date (	YYYY-MM-DD):		—	
Test Voltage	e applied (V, dc):		—	
Solution res	istivity (Ω cm):	< 3500 $\Omega$ cm at 22 $\pm$ 2°C	—	
Solution temperature (°C):			—	
Sample #	Measured (MΩ)	Required (MΩ)	Result	
5				
7				
9				
14				
15				
Supplement	tary information:			

Table 42: MST 03 - Maximum power determination final						
Test Date ()	(YYY-MM-DD)	:				_
Module temperature (°C):			25			_
Irradiance (W/m²):		1000			-	
Sample #	lsc (A)	Voc (V)	Imp (A)	Vmp (V)	Pmp (W)	FF (%)
1						
4						
5						
7						
9						
14						
15						
Supplement	ary information:					

Table 43: MST 01 - Final Visual inspection					
Test Date (	YYYY-MM-DD):		_		
Sample #	Findings	□ Yes□ No			
1	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
4	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
5	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
6	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
Sample # 9	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
Sample # 13	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
14	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
15	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
16	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
17	Nature and position of findings – comments or attach photos		—		
Sample #	Findings	□ Yes□ No			
Sample # 18	Nature and position of findings – comments or attach photos		—		
Sample # 19	Findings:	□ Yes□ No			
Supplemen	tary information:				

Page 64 of 84

Report No.

Table 44: MST 05 - Durability of markings							
Test Date (	YYYY-MM-DD)		:				—
Sample #	Markings	s legible	Not easily	/ removable	Νο οι	urling	Result
1	□ Yes	🗆 No	□ Yes	🗆 No	□ Yes	🗆 No	
4	□ Yes	🗆 No	□ Yes	🗆 No	□ Yes	🗆 No	
5	□ Yes	□ No	□ Yes	□ No	□ Yes	□ No	
7	□ Yes	□ No	□ Yes	□ No	□ Yes	□ No	
9	□ Yes	□ No	□ Yes	🗆 No	□ Yes	🗆 No	
14	□ Yes	□ No	□ Yes	□ No	□ Yes	□ No	
15	□ Yes	□ No	□ Yes	□ No	□ Yes	□ No	
Supplemen	tary information	:					

Table 45: M	Table 45: MST 06 - Sharp edge test						
Test Date (`	YYY-MM-DD):						
Sample #	Accessible surfaces free of sharp edges, burrs etc.	Result					
1							
4							
5							
7							
9							
14							
15							
Supplement	ary information:						

Table 46: MST 07 - Bypass diode functionality test					
Test Date (YYYY-MM-DD):					—
	A				—
Ambient ten	nperature [°C]				—
Current flow	/ applied [A]				—
Sample #	VFM	VFMrated	•	VFMrated) ±	Result
1			$\Box$ Yes	🗆 No	
4			□ Yes	🗆 No	
5			□ Yes	🗆 No	
7			□ Yes	🗆 No	
9			□ Yes	🗆 No	

TRF No. IS/IEC61730-1:2016 IS/IEC61730-2:2016

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			Page 65 of 84		R	eport No.	
14					□ Yes	🗆 No	
15					□ Yes	□ No	
	В						—
Sampla #			IV curve after s	hading			Regult
Sample #	Diode 1 working properly Diode 2 working properly		king properly	Diode 3 working properly		Result	
1	□ Yes	□ No	□ Yes	□ No	□ Yes	🗆 No	
4	□ Yes	□ No	□ Yes	□ No	□ Yes	🗆 No	
5	□ Yes	□ No	□ Yes	□ No	□ Yes	□ No	
7	□ Yes	□ No	□ Yes	□ No	□ Yes	🗆 No	
9	□ Yes	□ No	□ Yes	□ No	□ Yes	🗆 No	
14	□ Yes	□ No	□ Yes	□ No	□ Yes	□ No	
15	□ Yes	□ No	□ Yes	□ No	□ Yes	□ No	
Supplementary information:							

Page 66 of 84

Report No.

Table 47: MST 33a - Test for general screw connections				
Test Date (YY	YY-MM-DD):			
Sample #	Thread diameter [mm]	Torque [Nm]	Result	
1				
4				
5				
7				
9				
14				
15				
			•	

Supplementary information:

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Table 48: MST 33b - Test for locking screws					
Test Date (YYY-MM-DD)					
Sample #	Thread diameter [mm]	Torque [Nm]	Result		
1					
4					
5					
7					
9					
14					
15					
Supplementary	Supplementary information:				

Sample #	4			
Table 49: M	IST 04 - Insulation thickness test			
Test Date (	Test Date (YYYY-MM-DD):			
Max. Syste	m voltage:		—	
Thickness of	of insulation acc. datasheet:		—	
Required thickness of insulation:			—	
Measurement uncertainty:			—	
Location		Measured thickness (including uncertainty)	Result	
Supplemer	ntary information:			

### Page 67 of 84

### ANNEX 1: LIST OF TEST EQUIPMENT USED:

Application	Identification	Description

# Page 68 of 84 ANNEX 2: CONSTRUCTIONAL DETAILS / BILL OF MATERIAL (BOM)

5.3.2 Internal wiring					
Cell connector					
Manufacturer:	Туре:	Material:			
Thickness [µm]:	Dimension [mm]:	Coatings:			
Supplementary Information:					
String connector		NA-1-2-1			
Manufacturer:	Туре:	Material			
Thickness [µm]:	Dimension (mm):	Contingo			
Thickness [µm].	Dimension [mm]:	Coatings:			
Supplementary Information:					
5.3.3 External wiring and cab	les				
Cables					
Manufacturer:	Туре:	Material:			
Diameter [mm <sup>2</sup> ]:	Length [mm]:	Max. Temperature:			
Certified:  Yes /  No	Standards:	Others:			
Certifier and Cert. No.					
	□ EN 50618				
Supplementary Information:	LI EN 50018				
5.3.4 Connectors					
Manufacturer:	Туре:	Class:			
	туре.				
Max. Voltage:	Max. Current:	Max. Temperature:			
IP-rating:	Locked:				
	🗆 Yes / 🗆 No				
Certified:  Yes /  No	Standards:	Others:			
Certifier and Cert. No.	□ IEC 62852				
Supplementary Information:					
5.3.5 Junction boxes					
Manufacturer:	Туре:	Class:			
	1900.				
IP-rating:	Dimensions (I x w x h) [mm <sup>2</sup> ]:	Weight [g]:			
Max. Voltage:	Max. Current:	Max. Temperature:			
Electrical Termination cell side:	Electrical Termination cell side:	Number of Bypass Diodes			
Soldered	Soldered				
Welded	Welded				
Screwed	Screwed				
Screwless	Screwless				
		Standarda			
Potted:	Certified:   Yes /   No	Standards:			
	Certifier and Cert. No.	□ IEC 62790			
Supplementary Information:					

5.3.6 Frontsheets and backsheets

	0	•			
Frontsheet					
Used as:  Basic Insulation	Used as:  Basic Insulation Reinforced Insulation				
Total Dimensions (width x length	) [mm]:				
Material:	Manufacturer:	Type:			
Glass					
Thickness [mm]:	Heat strength.:   Yes /	Coating:  Ves /  No			
	No				
	Tempered	Description			
	□ Heat strengthened				
Structured:  Ves /  No	Certified:  Yes /  No	Standards:			
Description	Certifier and Cert. No.				
Supplementary Information:					
Single layer:	Used as: $\Box$ Basic Insulation $\Box$ F	Reinforced Insulation			
Material:	Manufacturer:	Type:			
		туре.			
Thickness [mm]	Thermal Index:	Material Group:			
Colour:	Certified	Standards:			
	Certifier and Cert. No.				
Supplementary Information:					
Multi-layer 🛛	Used as: $\Box$ Basic Insulation $\Box$ F	Reinforced Insulation			
Material:	Manufacturer:	Туре:			
Total Thickness [mm]:	No of layers:				
Layer No. 1 (air side)	Used as: $\Box$ Basic Insulation $\Box$ F	Reinforced Insulation			
Material:	Manufacturer:	Туре:			
Thickness [mm]	Thermal Index:	Material Group:			
	□ RTE °C				
	□ TI °C				
	□ RTI °C				
Colour:	Certified  Ves /  No	Standards:			
	Certifier and Cert. No.				
Layer No. 2	Used as: $\Box$ Basic Insulation $\Box$ F	Reinforced Insulation			
Material:	Manufacturer:	Type:			
Thickness [mm]	Thermal Index:	Material Group:			
Colour					
Colour:		Standards:			
	Certifier and Cert. No.				
Layer No. 3	Used as:  Basic Insulation  F				
Material:	Manufacturer:	Туре:			
Thickness [mm]	Thermal Index:	Material Group:			
	□ RTE °C				
	□ TI				
	=	·			

	Page 70 of 84	Report No.	
	□ RTI °C		
Colour:	Certified  Yes /  No	Standards:	
	Certifier and Cert. No.		
Layer No. n (Encapsulation side)	Used as:  Basic Insulation  I	Reinforced Insulation	
Material:	Manufacturer:	Туре:	
Thickness [mm]	Thermal Index:	Material Group:	
	□ RTE °C		
	□ TI °C		
	□ RTI °C		
Colour:	Certified   Yes /  No	Standards:	
	Certifier and Cert. No.		
Supplementary Information:			
Backsheet			
Used as:  Basic Insulation	Reinforced Insulation		
Material:	Manufacturer:	Туре:	
Glass			
Thickness [mm]:	Heat strength.:	Coating:  Ves /  No	
	Tempered	Description	
	<ul> <li>Heat strengthened</li> <li>Annealed</li> </ul>		
Structured:	Certified:  Yes /  No	Standards:	
Description	Certifier and Cert. No.		
Supplementary Information:			
Single layer:	Used as:  Basic Insulation  I	Reinforced Insulation	
Material:	Manufacturer:	Type:	
Thickness [mm]	Thermal Index:	Material Group:	
	□ RTE °C		
	□ TI °C		
	□ RTI °C		
Colour:	Certified  Yes /  No	Standards:	
	Certifier and Cert. No.		
Supplementary Information:			
Multi-layer	Used as: $\Box$ Basic Insulation $\Box$ I	Reinforced Insulation	
Material:	Manufacturer:	Type:	
Total Thickness [mm]:	No of layers:		
Layer No. 1 (air side)	Used as:  Basic Insulation  I	L Reinforced Insulation	
Material:	Manufacturer:		
Thickness [mm]	Thermal Index:	Material Group:	
• •	□ RTE °C		
	□ TI °C		
Colour:	Certified  Yes /  No	Standards:	
	Certifier and Cert. No.		
Layer No. 2		Reinforced Insulation	
Material:	Manufacturer:		
พลเธทลเ.	Manufacturer: Type:		

Page 71 of 84

Thickness [mm]	Thermal Index:	Material Group:		
	□ RTE °C			
	□ TI °C			
	□ RTI °C			
Colour:	Certified  Yes /  No	Standards:		
	Certifier and Cert. No.			
Layer No. 3	Used as:  Basic Insulation	Reinforced Insulation		
Material:	Manufacturer:	Type:		
Thickness [mm]	Thermal Index:	Material Group:		
• •	□ RTE °C			
	□ TI °C			
	□ RTI °C			
Colour:	Certified  Yes /  No	Standards:		
	Certifier and Cert. No.			
Layer No. n (Encapsulation	Used as: $\Box$ Basic Insulation $\Box$	Reinforced Insulation		
side)				
Material:	Manufacturer:	Туре:		
Thickness [mm]	Thermal Index:	Material Group:		
	□ RTE °C			
	□ TI °C			
	□ RTI °C			
Colour:	Certified	Standards:		
	Certifier and Cert. No.			
Supplementary Information:				
5.3.7 Insulation barriers / Ed	ge sealant			
	c Insulation   Reinforced Insulation	1		
Total Dimensions (width x length	ı) [mm]:			
Material:	Manufacturer:	Туре:		
Thickness [mm]	Thermal Index:	Material Group:		
	□ RTE °C			
	□ TI °C			
	□ RTI °C			
Colour:	Certified  Yes /  No	Standards:		
	Certifier and Cert. No.			
Supplementary Information:				
5.3.9 Encapsulants				
Used as:  Basic Insulation	□ Reinforced Insulation □ N/A			
Total Dimensions (width x length	ı) [mm]:			
Material: (Frontsheet side)	Manufacturer:	Туре:		
Thickness [mm]	Thermal Index:	Material Group:		
	□ RTE °C			
	□ TI °C			
	□ RTI °C			
Colour:	Certified	Standards:		
	Certifier and Cert. No.			
Material: (Backsheet side)	Manufacturer:	Туре:		
	manulation	1.120.		

Page 72 of 84

Report No.

Thickness [mm]	Thermal Index		Material Group:	
	🗆 RTE	°C		
	🗆 TI	°C		
	🗆 RTI	°C		
Colour:	Certified 🗆 Y	es / 🗆 No	Standards:	
	Certifier and C	ert. No.		

Supplementary Information:

5.5.2.3 Polymeric materials use	ed as electrical insulation			
Location:				
Application   External part  Support of live parts  Mechanical functions				
Used as:  Functional  Basic Insulation  Reinforced Insulation				
Material:	Manufacturer:	Туре:		
Flammability class:				
Thickness [mm]	Thermal Index:	Material Group:		
	□ RTE °C			
	□ TI °C			
	□ RTI °C			
Colour:	Certified  Ves /  No	Standards:		
	Certifier and Cert. No.			
Supplementary Information:				
Location:				
Application	Support of live parts	Mechanical functions		
Used as:  Functional  Basic	Insulation   Reinforced Insulation	1		
Material:	Manufacturer:	Туре:		
Flammability class:				
Thickness [mm]	Thermal Index:	Material Group:		
	□ RTE °C			
	□ TI °C			
	□ RTI °C			
Colour:	Certified  Ves /  No	Standards:		
	Certifier and Cert. No.			
Supplementary Information:				

5.3.10 Bypass Diodes			
Manufacturer:	Туре:		
Nominal current of diode I <sub>F</sub> (A)			
R <sub>THJ-C</sub> (K/W) / R <sub>THJ-L</sub> (K/W)			
Max. T <sub>J</sub> (°C)			
Max. V <sub>F</sub> at I <sub>F</sub> (V)			
Supplementary Information:			

5.4.2 / 5.4.4	Screws			
Application		Kind of screw:	Dimension (diameter/length)	Material
			(u.u.u.u.u.u.u.u.u.u.u.u.u.u.u.u.u.u.u.	

Supplementary Information:

5.4.3 Rivets		
Application	Dimension (diameter/length)	Material:
Supplementary Information:		

5.4.6 Adhesives			
For Junction Boxes			
Manufacturer:	Туре:		
Additional function as: 🗆 Basic	Insulation   Reinforced Insu	lation 🗆 N/A	
Thickness [mm]	Thermal Index:	Material Group:	
	□ RTE °C		
	□ TI °C		
	□ RTI °C		
Supplementary Information:			
For Frames / Backrails			
Additional function as:   Basic	Insulation	lation 🗆 N/A	
Manufacturer:	Туре:		
Additional function as: 🗆 Basic	c Insulation   Reinforced Insulation  N/A		
Thickness [mm]	Thermal Index:	Material Group:	
	□ RTE °C		
	□ TI °C		
	□ RTI °C		
Supplementary Information:			

5.5.3 Metallic Materials					
Frame / Corner joint / Backrail:					
Manufacturer:	Type: Dimension				
Supplementary Information:					
Others:					
Manufacturer:	Туре:	Dimension			
Supplementary Information:					

Cell

Page 74 of 74

Report No.

Kind of cell	Manufacturer:	Туре:
🗆 cSi 🗆 CdTe 🗆 aSi 🗆 CiGs		
Thickness [µm]:	Dimension [mm]:	Number of busbars:
Supplementary Information:	<u>.</u>	

Cell fixing Tape						
No.	Material	Manufacturer	Туре		Ratings	
1						
2						
3						

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